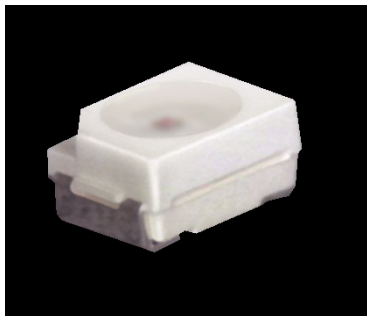
SML-Z14x/ZN4x Series

Data Sheet

■Features

- High brightness
- 20/50mA guaranteed specifications
- PLCC2 package

■Outline

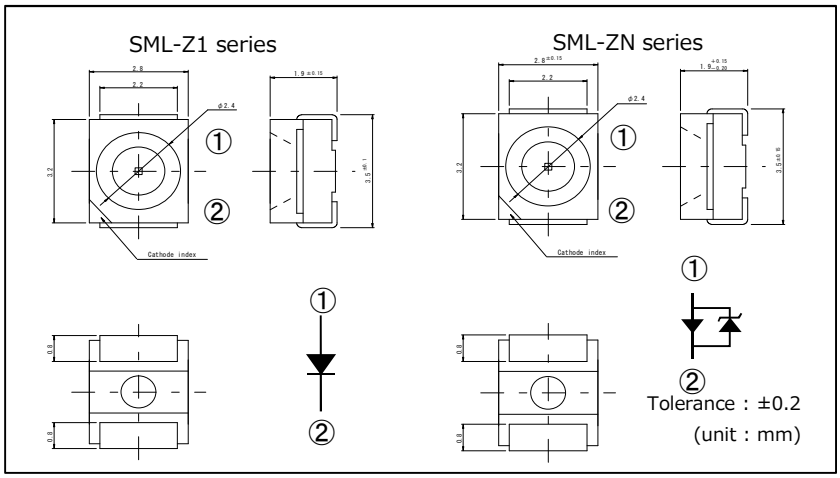


■Size

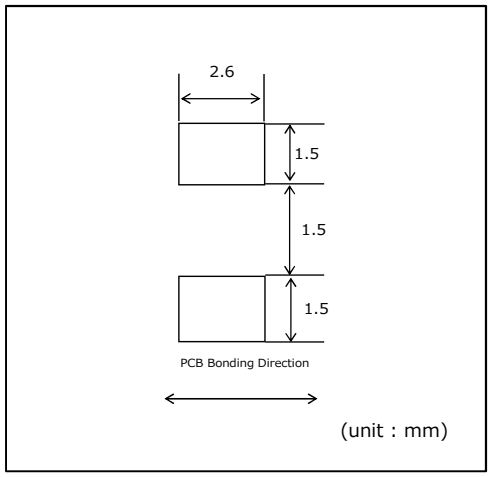
3528 (1411)
3.5×2.8mm (t=1.9mm)

Color Type: V U D Y M / F P E B WB

■Dimensions



■Recommended Solder Pattern



■Specifications

Part No.	Chip Structure	Emitting Color	Absolute Maximum Ratings (Ta=25ºC)						Electrical and Optical Characteristics (Ta=25ºC)										
			Power Dissipation P_D(mW)	Forward Current I_F(mA)	Peak Forward Current I_{FP}(mA)	Reverse Voltage V_R(V)	Operating Temp. T_{opr}(ºC)	Storage Temp. T_{stg}(ºC)	Forward Voltage V_F Typ. (V)	V_F I_F (mA)	Reverse Current I_R Max. (μA)	I_R V_R (V)	Dominant Wavelength λ_D /Chromaticity coordinate(x,y) Min.*2 (nm)	Typ. (nm)	Max.*2 (nm)	λ_D I_F (mA)	Luminous Intensity I_V Min. (mcd)	Typ. (mcd)	I_V I_F (mA)
SML-Z14VT(A)	AlGaInP	Red	168	70	200*1	12	-40 ～ +100	-40 ～ +100	1.9	20	10	12	625	630	635	20	56	112	20
SML-Z14UT(A)													615	620	625		112	224	
SML-Z14DT(A)		Orange											602	605	608		140	280	
SML-Z14YT(A)		Yellow	175						2.0				586	589	592				
SML-Z14MT(A)		Yellowish Green											568	571	574		45	90	
SML-Z14FT(A)		Green											561.5	564	566.5		22.4	45	
SML-Z14PT(A)													557	560	563		11.2	22.4	
SML-Z14V4T		Red	189						2.0	50			-	630	-	50	140	280	50
SML-Z14U4T													-	620	-		280	560	
SML-Z14D4T		Orange							2.1				-	605	-		355	710	
SML-Z14Y4T		Yellow											587	590	593				
SML-Z14M4T		Yellowish Green											569	572	575		112	224	
SML-Z14F4T		Green											-	565	-		56	120	
SML-Z14P4T													-	561	-		22.4	56	
SMLZ14EGT(A)	InGaN	Green	120	30	100*1	5	-40 ～ +85		3.4	20	10	5	519	528	536	20	710	1100	20
SMLZ14BGT(A)		Blue	114						3.3				464	470	476		140	280	
SMLZN4BGT(A)						—					-	-	464	470	476		140	300	
SMLZN4WBGUW(A) *3		White											(x, y) (0.30, 0.28)				1800	2400	

*1 : 1/10,1kHz *2 : Measurement tolerance:±1nm、*3:Brightness for white color is noted with chromaticity coordinate(x,y).

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Electrical Characteristics Curves

Reference

Fig.1 Forward Current - Forward Voltages

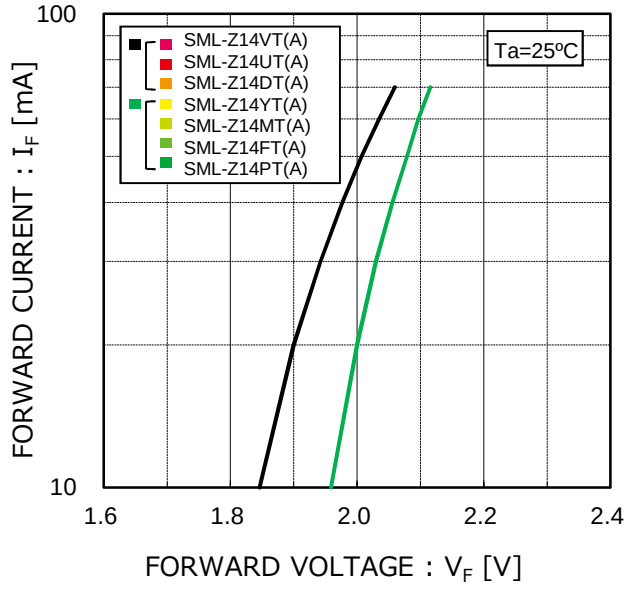


Fig.2 Luminous Intensity - Atmosphere Temperature

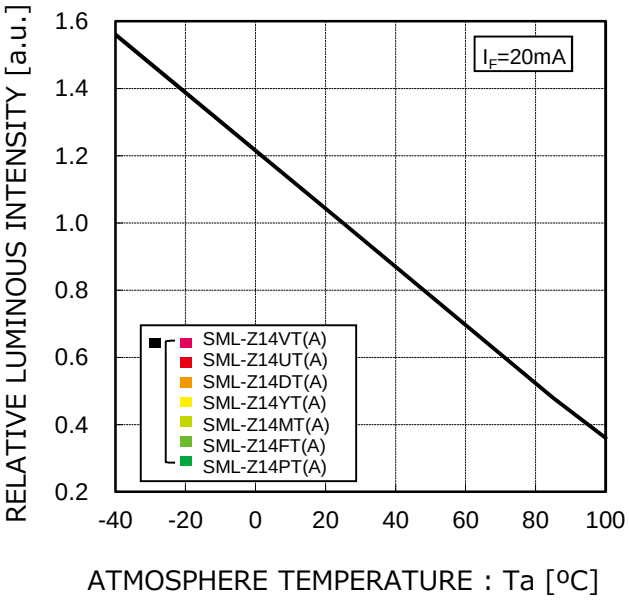


Fig.3 Luminous Intensity - Forward Current

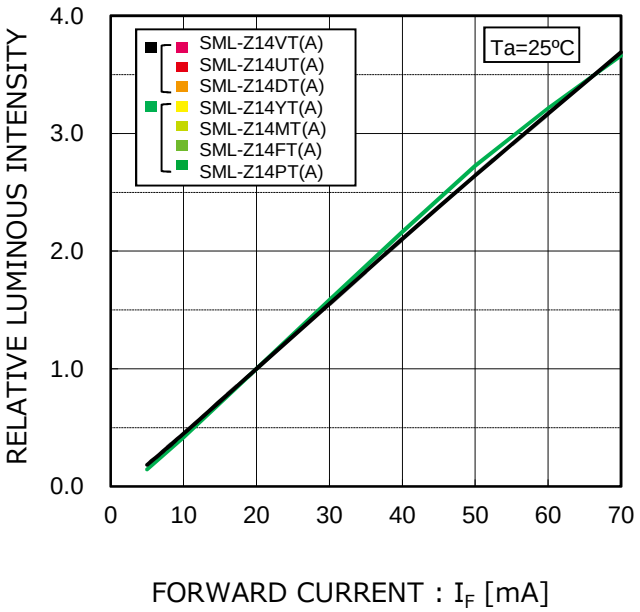
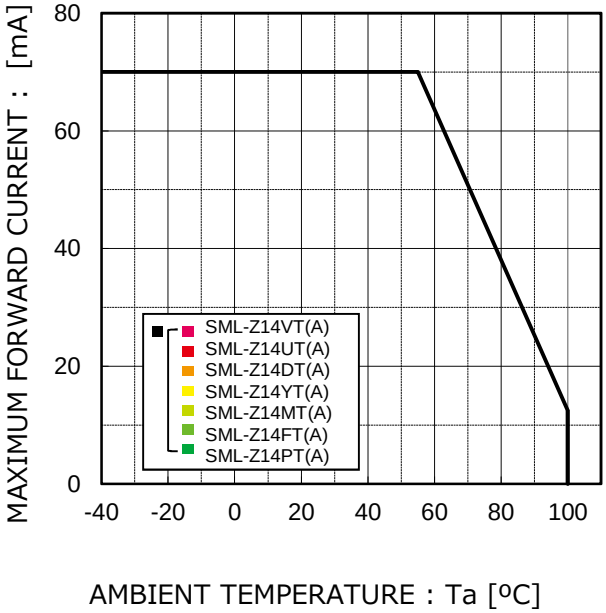


Fig.4 Derating



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■ Electrical Characteristics Curves

Reference

Fig.1 Forward Current - Forward Voltages

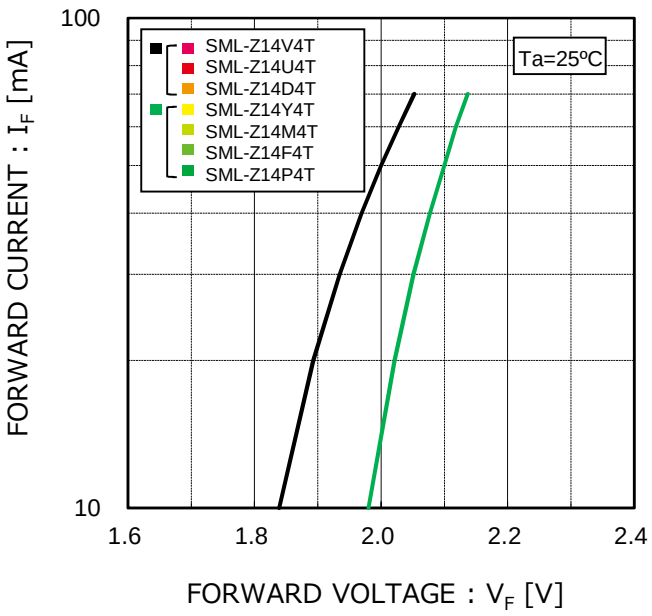


Fig.2 Luminous Intensity - Atmosphere Temperature

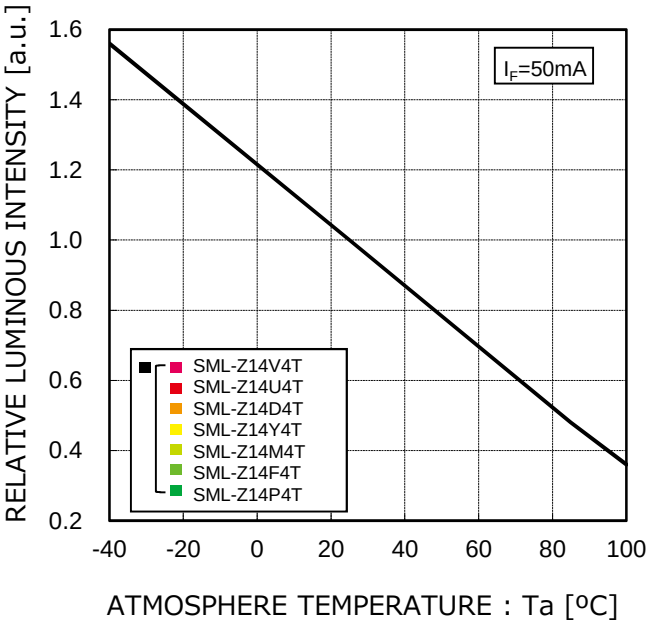


Fig.3 Luminous Intensity - Forward Current

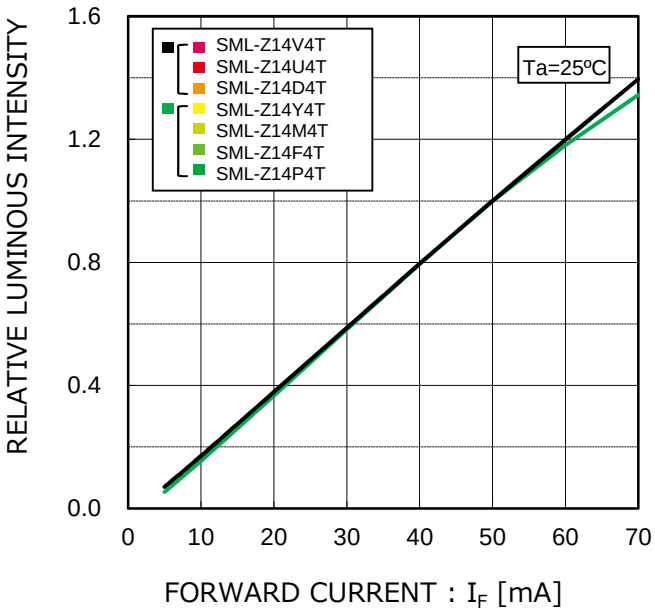
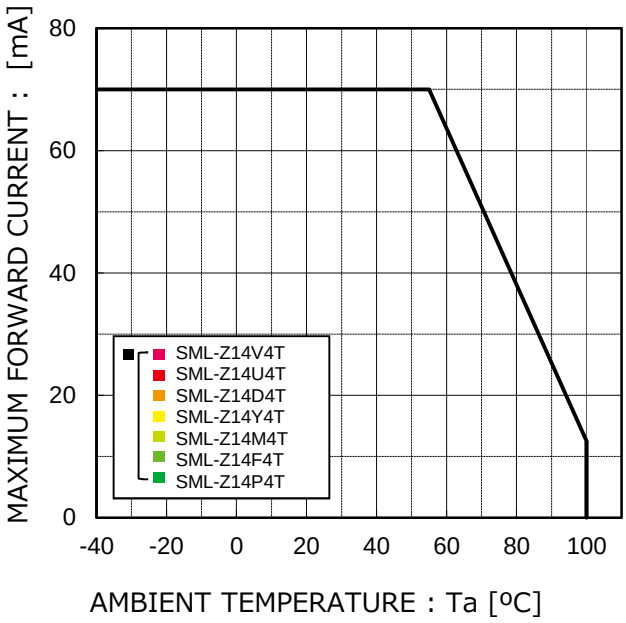


Fig.4 Derating



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■Electrical Characteristics Curves

Reference

Fig.1 Forward Current - Forward Voltages

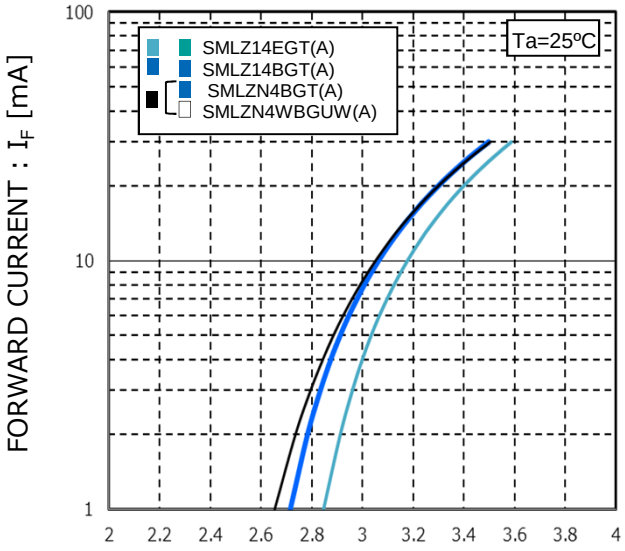


Fig.2 Luminous Intensity - Atmosphere Temperature

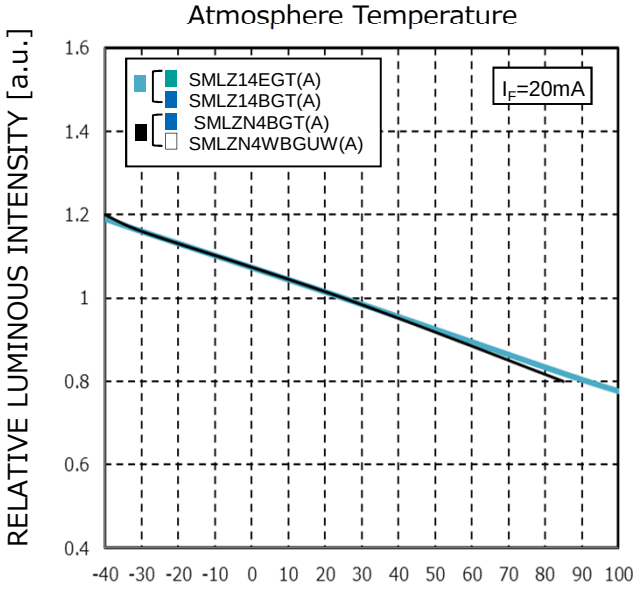


Fig.3 Luminous Intensity - Forward Current

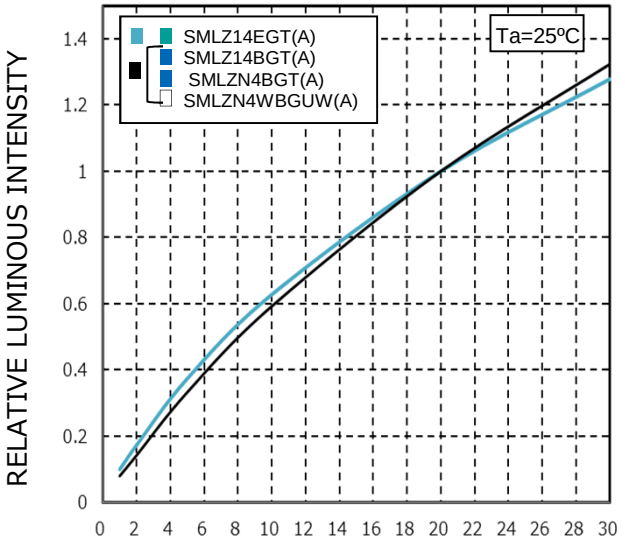
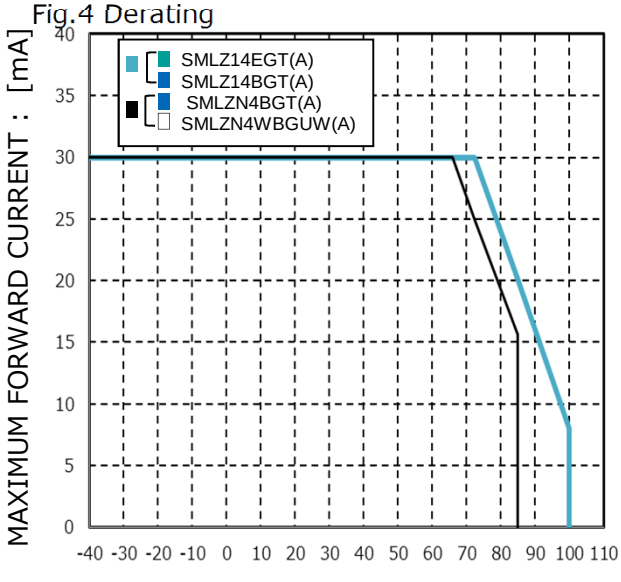


Fig.4 Derating



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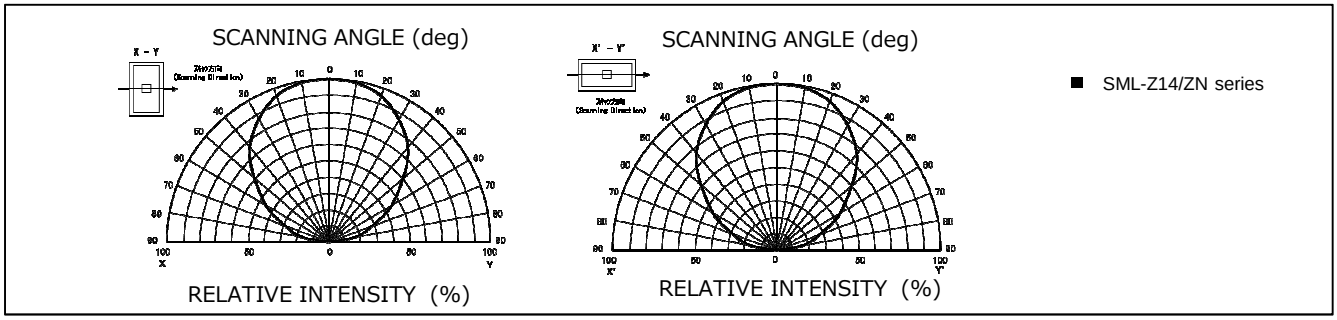
■Viewing Angle

Reference



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■Rank Reference of Brightness*

*Measurement tolerance:±10%

Red(V,U)

(Ta=25ºC, I_F=20mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14VT(A)																		
SML-Z14UT(A)																		

(Ta=25ºC, I_F=50mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14V4T																		
SML-Z14U4T																		

Orange(D)

(Ta=25ºC, I_F=20mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14DT(A)																		

(Ta=25ºC, I_F=50mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14D4T																		

Yellow(Y)

(Ta=25ºC, I_F=20mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14YT(A)																		

(Ta=25ºC, I_F=50mA)

Rank	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ	BA	BB	BC	BD	BE
Iv (mcd)	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560	560~710	710~900	900~1120	1120~1400	1400~1800
SML-Z14Y4T																		

Yellowish Green/Green(M,P,F)

(Ta=25ºC, I_F=20mA)

Rank	AG	AH	AJ	AK	AL	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ
Iv (mcd)	9~11.2	11.2~14	14~18	18~22.4	22.4~ 28	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560
SML-Z14MT(A)																		
SML-Z14PT(A)																		
SML-Z14FT(A)																		

(Ta=25ºC, I_F=50mA)

Rank	AG	AH	AJ	AK	AL	AM	AN	AP	AQ	AR	AS	AT	AU	AV	AW	AX	AY	AZ
Iv (mcd)	9~11.2	11.2~14	14~18	18~22.4	22.4~ 28	28~35.5	35.5~45	45~56	56~71	71~90	90~112	112~140	140~180	180~224	224~280	280~355	355~450	450~560
SML-Z14M4T																		
SML-Z14P4T																		
SML-Z14F4T																		

Green(E)

(Ta=25ºC, I_F=20mA)

Rank	S1	S2	T1	T2	U1	U2	V1	V2	W1	W2	X1	X2	Y1	Y2	Z1	Z2
Iv (mcd)	90~110	110~140	140~180	180~220	220~280	280~360	360~450	450~560	560~710	710~900	900~1100	1100~1400	1400~1800	1800~2200	2200~2800	2800~3600
SMLZ14EGT(A)																

Blue(B)

(Ta=25ºC, I_F=20mA)

Rank	S1	S2	T1	T2	U1	U2	V1	V2	W1	W2	X1	X2	Y1	Y2	Z1	Z2
Iv (mcd)	90~110	110~140	140~180	180~220	220~280	280~360	360~450	450~560	560~710	710~900	900~1100	1100~1400	1400~1800	1800~2200	2200~2800	2800~3600
SMLZ14BGT(A)																
SMLZN4BGT(A)																

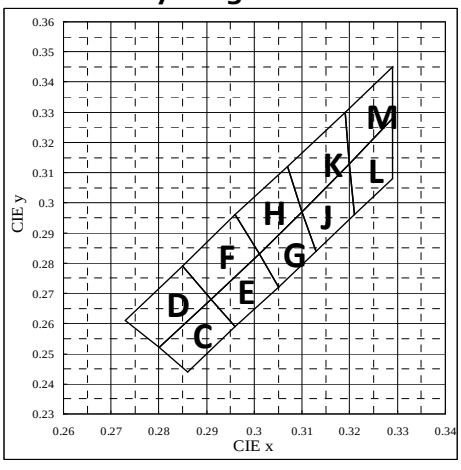
White(WB)

(Ta=25ºC, I_F=20mA)

Rank	S1	S2	T1	T2	U1	U2	V1	V2	W1	W2	X1	X2	Y1	Y2	Z1	Z2	Z3
Iv (mcd)	90~110	110~140	140~180	180~220	220~280	280~360	360~450	450~560	560~710	710~900	900~1100	1100~1400	1400~1800	1800~2200	2200~2800	2800~3600	3600~4500
SMLZN4WBGUW(A)																	

*Please note that the brightness of some products may fall between ranks (half rank).

■Chromaticity Diagram



(Ta=25℃、If=20mA)

C		D		E		F		G	
x	y	x	y	x	y	x	y	x	y
0.296	0.259	0.291	0.268	0.296	0.259	0.291	0.268	0.305	0.272
0.291	0.268	0.285	0.279	0.291	0.268	0.285	0.279	0.301	0.283
0.280	0.252	0.273	0.261	0.301	0.283	0.296	0.296	0.310	0.297
0.286	0.244	0.280	0.252	0.305	0.272	0.301	0.283	0.313	0.284

H		J		K		L		M	
x	y	x	y	x	y	x	y	x	y
0.301	0.283	0.310	0.297	0.307	0.312	0.320	0.313	0.319	0.330
0.296	0.296	0.320	0.313	0.319	0.330	0.329	0.328	0.329	0.345
0.307	0.312	0.321	0.296	0.320	0.313	0.329	0.308	0.329	0.328
0.310	0.297	0.313	0.284	0.310	0.297	0.321	0.296	0.320	0.313

Measurement tolerance : ±0.01

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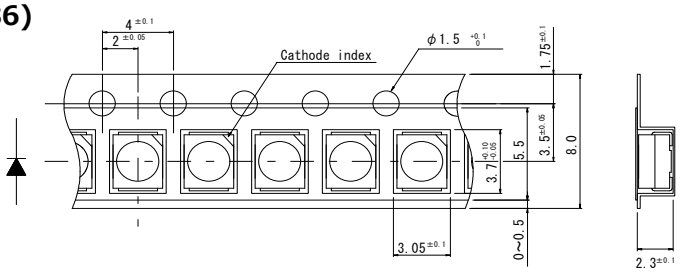
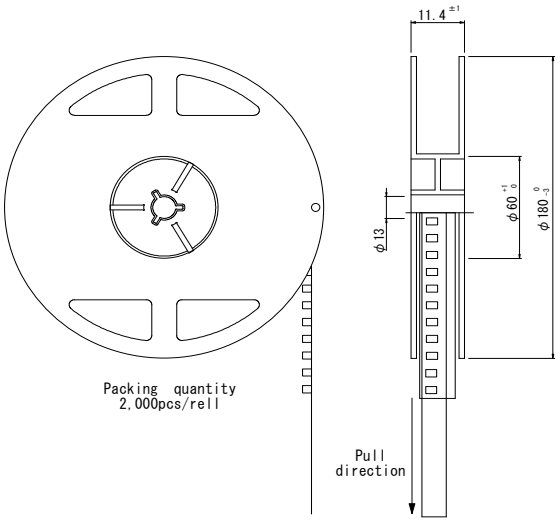
■Taping(T86)





Unit:mm

Note)Tolerance is within ±0.2mm unless otherwise specified.

■Part No. Construction

*"-"will be taken out for emitting color WB/B/E series.

Special Code will be applied for Emitting color WB/B/E series.

Chromaticity rank (for white LED)

Rank sign (Brightness Rank)*

S	M	L	–	Z	1	4	Y	4	T	T	8	6		P

Series name | Package Type | Chip type | Emitting Color | Resin Color | Taping Specification

SML	Chip LED
SCM	Chip LED

P1	1.0x0.6 t=0.2mm
E1	1.6x0.8 t=0.36mm
D1	1.6x0.8 t=0.55mm
H1 / M1	2.0x1.25 t=0.8mm
01	3.0x2.0 t=1.3mm
Z1/ZN	3.5x2.8 t=1.9mm
A1	1.6x1.15 t=0.55mm
81/82	3.4x1.25 t=1.1mm
K1	4.5x2.0 t=0.6mm
S1	3.2x1.6 t=1.85mm
P2	1.0x1.0 t=0.2mm
52	1.3x1.5 t=0.6mm
P34	1.0x1.0 t=0.2mm
P36	1.5x1.0 t=0.2mm
VN	3.5x2.8 t=0.6mm
01	3.0x1.5 t=2.2mm

0	Standard Type
1	Low Current Type
2	High Brightness type
3 / 4 / 5 / 6 / 7 / 8	Ultra High Brightness type

V	Red
U	Red
U2	Red
D	Orange
Y3	Yellow
Y2	Yellow
Y	Yellow
W	Yellow
M2	Yellowish green
M	Yellowish green
F	Green
P	Green
E	Green
B	Blue
WB	White
T	Phototransistors
RGB	Red/Green/Blue

T	Transparent Colorless
W	Milkey White
B	Black

T86	Cathode at sprocket hole side(the top)
T87	Anode at sprocket hole side(the top)
1	For white LED,
3	csthode at sprocket hole side

notice) S1 series、81 seires

T86	Cathode at sprocket hole side(the back)
T68	Cathode at sprocket hole side(the top)

*Concerning the Brightness rank.
*Please refer to the rank chart above for luminous intensity classification.
*Part name is individual for each rank.
*When shipped as sample,the part name will be a representative part name.
General products are free of ranks.
Please contact sales if rank appointment is needed.

■Packing Specification

ROHM LED products are being shipped with desiccant (silica gel) included in moisture-proof bags.
Pasting the moisture sensitive label on the outer surface of the moisture-proof bags or enclosing the humidity indication card inside the bag is available upon request.
Please contact the nearest sales office or distributer if necessary.

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■Precaution (Surface Mount Device)

1．Storage

If the product is heated during the reflow under the condition of hygroscopic state, it may vaporize and expand which will influence the performance of the product. Therefore, the package is waterproof. Please use the product following the conditions:

・Using Conditions

Classification	Temperature	Humidity	Expiration Date	Remark
①Before using	5～30℃	30～70%RH	Within 1 year from Receiving	Storage with waterproof package
②After opening package	5～30℃	Below 70%RH	Within 72h	Please storing in the airtight container with our desiccant (silica gel)

・Baking

Bake the product in case of below:
①The expiration date is passed.
②The color of indicator (silica gel) turned from blue to colorless or from green to pink.
(Even if the product is within the expiration date.)

・Baking Conditions

Temperature	Time	Humidity
60±3℃	40～48h	Below 20%RH
Remark	・Bake products in reel. ・Reel and embossed tape are easy to be deformed when baking, so please try not to apply stress on it. ・Recommend bake once.	

2．Application Methods

2－1．Precaution for Drive System and Off Mode

Design the circuit without the electric load exceeding the ABSOLUTE MAXIMUM RATING that applies on the products. If drive by constant voltage, it may cause current deviation of the LED and result in deviation of luminous intensity, so we recommend to drive by constant current. (Deviation of VF Value will cause deviation of current in LED.) Furthermore, for off mode, please do not apply voltage neither forward nor reverse. Especially, for the products with the Ag-paste used in the die bonding, there's high possibility to cause electro migration and result in function failure.

2－2．About Derating

It is considered that derating characteristics will not result in LED chip's electrical destruction. Even within the derating, the reliability and luminous life can be affected depending on operating conditions and ambient environment. So we would be appreciate it if you can confirm with your application again.

2－3．About product life

Depending on operating conditions and environment(applied current, ambient temperature and humidity, corrosive gas), decreasing of luminosity and change of chromaticity may occur even within the specification conditions.
Please contact our sales office if you use it for the following applications.
①It requires long luminosity life
②It is always lit

2－4．Applied Stress on Product

The top of the LED is very soft, which the silicon resin is used as sealing resin.
Therefore, please pay attention to the overstress on it which may influence its reliability.

2－5．Usage

The Product is LED. We are not responsible for the usage as the diode such as Protection Chip, Rectifier, Switching and so on.

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3. Others

3 – 1. Surrounding Gas

Notice that if it is stored under the condition of acid gas (chlorine gas, sulfured gas) or alkali gas (ammonia), it may result in low soldering ability (caused by the change in quality of the plating surface) or optical characteristics changes (light intensity, chrominance) and change in quality of cause die bonding (Ag-paste) materials. All of the above will function failure of the products.
Therefore, please pay attention to the storage environment for mounted product (concern the generated gas of the surrounding parts of the products and the atmospheric environment).

3 – 2. Electrostatic Damage

The product is part of semiconductor and electrostatic sensitive, there's high possibility to be damaged by the electrostatic discharge. Please take appropriate measures to avoid the static electricity from human body and earthing of production equipment. Especially, InGaN type LEDs have lower resistance value of electrostatic discharge and it is recommended to introduce the ESD protection circuit.
The resistance values of electrostatic discharge (actual values) vary with products, therefore, please call our Sales staffs for inquiries.

3 – 3. Electromagnetic Wave

Applications with strong electromagnetic wave such as, IH cooker, will influence the reliability of LED, therefore please evaluate before using it.

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4． Mounting

4 – 1． Soldering

・No resin hardening agent such as filler is used in the sealing resin of the product. Therefore, resin expansion and moisture absorption at humidity will cause heat stress during soldering process and finally has bad influence on the product's reliability.
・The product is not guaranteed for flow soldering.
・Do not expose the product in the environment of high temperature (over 100℃) or rapid temperature shift (within 3℃/sec. of temperature gradient) during the flow soldering of surrounding parts.
In case of carrying out flow soldering of surrounding parts without recommended conditions, please contact us for inquiries.
・Please set appropriate reflow temperature based on our product usage conditions and specification.
・The max for reflowing is 2 times, please finish the second reflow soldering and flow soldering with other parts within the usage limitation after open the moistureproof package.
・Compare with N2 reflow, during air reflow, because of the heat and surrounding conditions, it may cause the discoloration of the resin.
・For our product that has no solder resist, because of its solder amount and soldering conditions, one of its specific characteristics is that solder will penetrate into LED. Thus, there's high possibility that will influence its reliability.Therefore, please be informed, concerning it before using it.

4 – 2． Automatic Mounting

4 - 2 - 1 . Silicon Resin Sealing Product

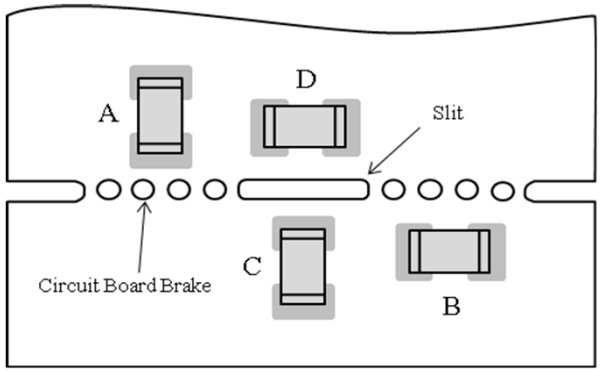
The sealing resin of LED is very soft, so please select adsorption nozzle that would not apply stress directly on the sealing section.

4 - 2 - 2 . Mini Package (Smaller than 1608 size)

・Vibration may result in low mounting rate since it will cause the static electricity of product and adhere to top cover tape. Therefore, the magnet should be set on parts feeder cassette of the mounter to control the product stabilization. In addition, it is recommended to set ionizer to prevent electrostatic charge.

4 – 3 . Mounting Location

The stress like bending stress of circuit board dividing after mounting, may cause LED package crack or damage of LED internal junction, therefore, please concern the mounting direction and position to avoid bending or screwing with great stress of the circuit board.



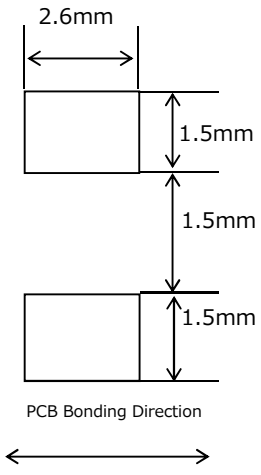
Stress strength according to he mounting position:
A> B> C> D

4—4 . Mechanical Stress after Mounting

The mechanical stress may damage the LED after Circuit Mounting, so please pay attention to the touch on product.

4 – 5． Soldering Pattern for Recommendation

We recommend the soldering pattern that shows on the right.
It will be different according to mounting situation of circuit board, therefore, please concern before designing.



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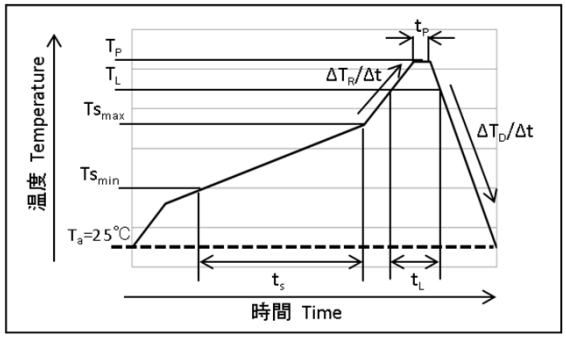
4 – 6. Reflow Profile

For reflow profile, please refer to the conditions below:(※)

■Meaning of marks, Conditions

Mark	Meanings	Conditions
Ts_{max}	Maximum of pre-heating temperature	180℃
Ts_{min}	Minimum of pre-heating temperature	140℃
t_s	Time from Tsmin to Tsmax	Over 60sec.
T_L	Reference temperature	230～250℃
t_L	Retention time for TL	Within 40sec.
T_P	Peak temperature	250℃(Max)
t_P	Time for peak temperature	Within 10sec.
$\Delta T_R/\Delta t$	Temperature rising rate	Under 3℃/sec.
$\Delta T_D/\Delta t$	Temperature decreasing rate	Over -3℃/sec.



※Above conditions are for reference. Therefore, evaluate by customer's own circuit boards and reflow furnaces before using, because stress from circuit boards and temperature variations of reflow furnaces vary by customer's own conditions.

4 – 7. Attention Points in Soldering Operation

This product was developed as a surface mount LED especially suitable for reflow soldering.
So reflow soldering is recommended. In case of implementing manual soldering,
please take care of following points.

①SOLDER USED

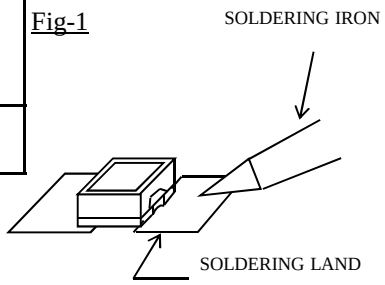
Sn-Cu, Sn-Ag-Cu, Sn-Ag-Bi-Cu

②HAND SOLDERING CONDITION

LED products do not contain reinforcement material such as a glass fillers.
So thermal stress by soldering greatly influence its reliability.
Please keep following points for manual soldering.

	ITEM	RECOMMENDED CONDITION
a)	Heating method	Condition) Temp. of iron top less than 325℃ within 3 sec. Heating on PCB pattern, not direct to the LED. (Fig-1)
b)	Handling after soldering	Please handle after the part temp. goes down to room temp.

Fig-1



4 – 8. Cleaning after Soldering

Please follow the conditions below if the cleaning is necessary after soldering.

Solvent	We recommend to use alcohols solvent such as, isopropyl alcohols
Temperature	Under 30℃ within 3 minutes
Ultrasonic Cleaning	15W／Below 1 liter (capacity of tank)
Drying	Under 100℃ within 3 minutes

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Notes

1) The information contained herein is subject to change without notice.

2) Before you use our Products, please contact our sales representative and verify the latest specifications :

3) Although ROHM is continuously working to improve product reliability and quality, semiconductors can break down and malfunction due to various factors.
Therefore, in order to prevent personal injury or fire arising from failure, please take safety measures such as complying with the derating characteristics, implementing redundant and fire prevention designs, and utilizing backups and fail-safe procedures. ROHM shall have no responsibility for any damages arising out of the use of our Poducts beyond the rating specified by ROHM.

4) Examples of application circuits, circuit constants and any other information contained herein are provided only to illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

5) The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM or any other parties. ROHM shall have no responsibility whatsoever for any dispute arising out of the use of such technical information.

6) The Products are intended for use in general electronic equipment (i.e. AV/OA devices, communication, consumer systems, gaming/entertainment sets) as well as the applications indicated in this document.

7) The Products specified in this document are not designed to be radiation tolerant.

8) For use of our Products in applications requiring a high degree of reliability (as exemplified below), please contact and consult with a ROHM representative : transportation equipment (i.e. cars, ships, trains), primary communication equipment, traffic lights, fire/crime prevention, safety equipment, medical systems, servers, solar cells, and power transmission systems.

9) Do not use our Products in applications requiring extremely high reliability, such as aerospace equipment, nuclear power control systems, and submarine repeaters.

10) ROHM shall have no responsibility for any damages or injury arising from non-compliance with the recommended usage conditions and specifications contained herein.

11) ROHM has used reasonable care to ensur the accuracy of the information contained in this document. However, ROHM does not warrants that such information is error-free, and ROHM shall have no responsibility for any damages arising from any inaccuracy or misprint of such information.

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sml-z14v4t - Web Page

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Distribution Inventory

Part Number	sml-z14v4t
Package	SML-Z1/ZN
Unit Quantity	2000
Minimum Package Quantity	2000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes

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